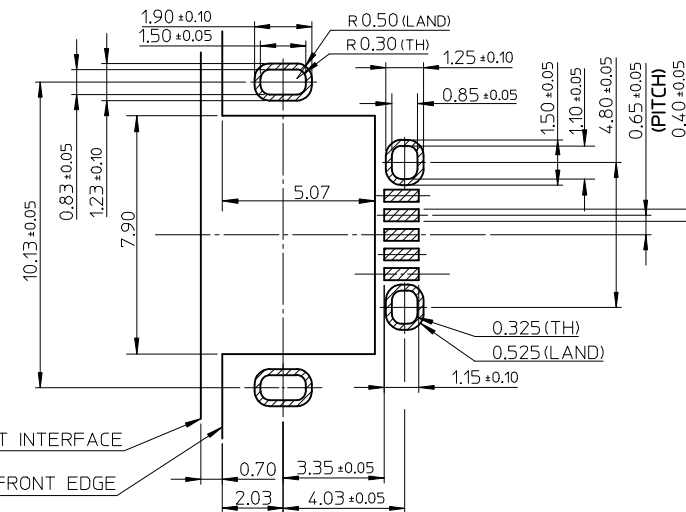
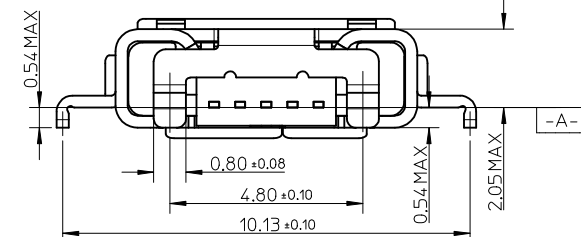


NOTES:

- MATERIAL:
HOUSING: LCP, BLACK, UL94V-0;
TERMINAL: COPPER ALLOY, THICKNESS: 0.15mm;
SHIELD CASE: STAINLESS STEEL, THICKNESS: 0.30mm.
- PLATING:
TERMINAL: CONTACT AREA: GOLD FLASH (0.11 MICRON MINIMUM) OVER MINIMUM 0.75 MICRON Pd/Ni;
SOLDER TAIL AREA: GOLD FLASH (0.05 MICRON MINIMUM);
UNDER PLATING: NICKEL 2.0 MICROMN MINIMUM.
SHIELD: MATTE TIN 1.27 MICRON MINIMUM.
UNDER PLATING: NICKEL 1.27 MICRON MINIMUM.
- TAIL COPLANARITY 0.08mm MAXIMUM.
- PRODUCT SPECIFICATION: PS-47589-001; PACKAGING SPECIFICATION: PK-47654-001.
- COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC.



RECOMMENDED PCB LAYOUT (Thickness=0.6mm~1.2mm)



REVISED EC NO: SH2013-0426 DRW: X07ZHANG CHKD: X07ZHANG APPR: AYIN	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	$F_A = 0$	mm	INCH	DRAWN BY XJSONG	DATE 2008/03/26	TITLE MICRO USB AB REC. SINK TYPE ASS'Y			
	$F_C = 0$	4 PLACES ± ---	± ---	CHECKED BY JTIAN	DATE 2008/03/26	molex			
	$F_P = 0$	3 PLACES ± ---	± ---	APPROVED BY HWWANG	DATE 2008/03/26				
		2 PLACES ± 0.15	± ---	MATERIAL NO. 47654-0001		DOCUMENT NO. SD-47654-001	SHEET NO. 1 OF 1		
		1 PLACE ± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS					
		0 PLACE ± ---	± ---	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					